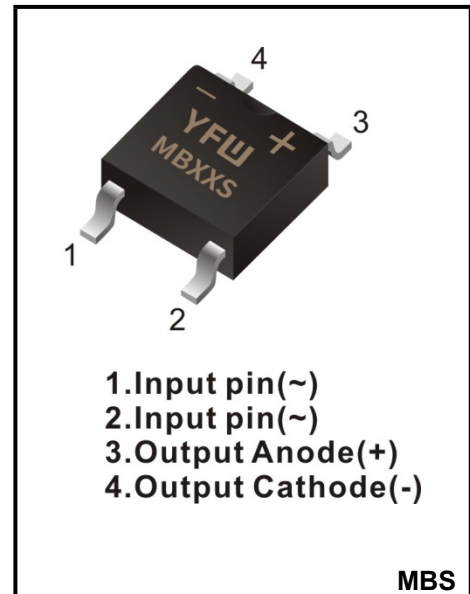


**0.5A SURFACE MOUNT GLASS PASSIVATED BRIDGE**
**RECTIFIER Reverse Voltage - 100 to 1000 V**
**Forward Current – 0.5A**
**FEATURES**

- ◆High current capability
- ◆Low forward voltage drop
- ◆Glass Passivated Chip Junction
- ◆Low power loss, high efficiency
- ◆Lead free in comply with EU RoHS 2011/65/EU directives

**MECHANICAL DATA**

- ◆Case: MBS
- ◆Terminals: Solderable per MIL-STD-750, Method 2026
- ◆Approx. Weight: 100mg / 0.0035oz



- 1.Input pin(~)
- 2.Input pin(~)
- 3.Output Anode(+)
- 4.Output Cathode(-)

**MBS**
**Maximum Ratings and Electrical characteristics**

Ratings at 25 °C ambient temperature unless otherwise specified.

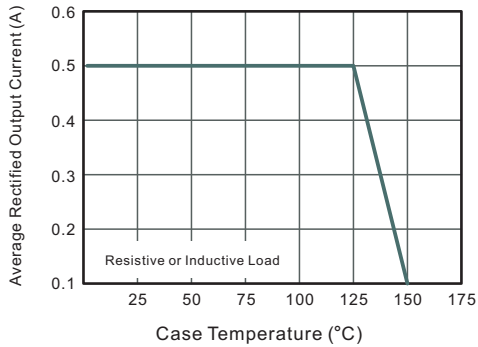
Single phase half-wave 60 Hz, resistive or inductive load, for capacitive load current derate by 20 %.

Parameter	Symbols	MB1S-05	MB2S-05	MB4S-05	MB6S-05	MB8S-05	MB10S-05	Units
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	100	200	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	100	200	400	600	800	1000	V
Average Rectified Output Current at $T_c = 125\text{ }^\circ\text{C}$	$I_o$	0.5						A
Peak Forward Surge Current 8.3 ms Single Half Sine-Wave Superimposed on Rated Load(JEDEC method)	$I_{FSM}$	20						A
Forward Voltage per element at 0.5A	$V_F$	1.1						V
Maximum DC Reverse Current @ $T_A=25\text{ }^\circ\text{C}$ at Rated DC Blocking Voltage @ $T_A=125\text{ }^\circ\text{C}$	$I_R$	5 40						$\mu\text{A}$
Typical Junction Capacitance (Note1)	$C_j$	11						pF
Typical Thermal Resistance (Note2)	$R_{\theta JA}, R_{\theta JC}$	115/35						$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_j, T_{stg}$	-55 ~ +150						$^\circ\text{C}$

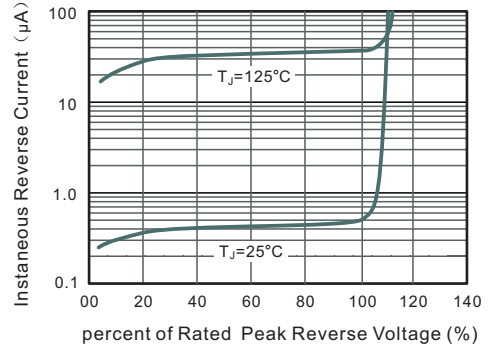
(1) Measured at 1 MHz and applied reverse voltage of 4 V D.C

(2) Mounted on glass epoxy PC board with 4×1.5"×1.5" (3.81×3.81 cm) copper pad.

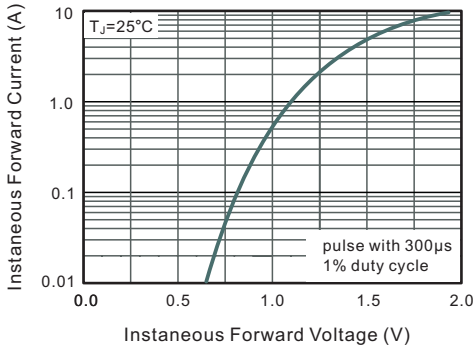
**Fig.1 Average Rectified Output Current Derating Curve**



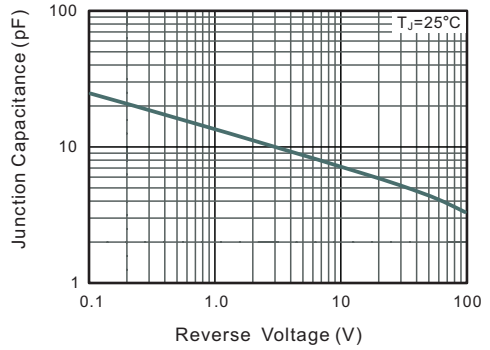
**Fig.2 Typical Reverse Characteristics**



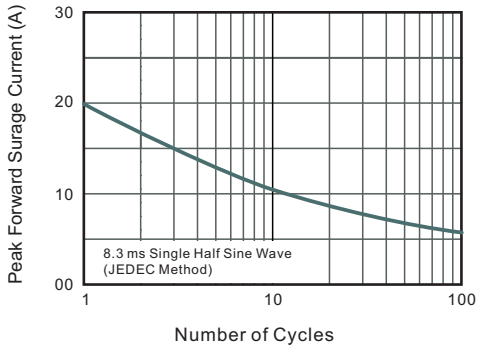
**Fig.3 Typical Instantaneous Forward Characteristics**



**Fig.4 Typical Junction Capacitance**



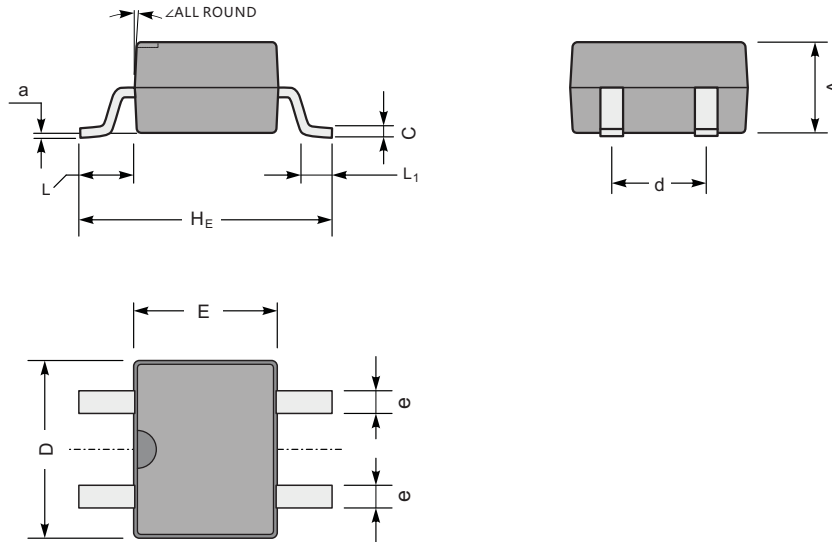
**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



**Package Outline**

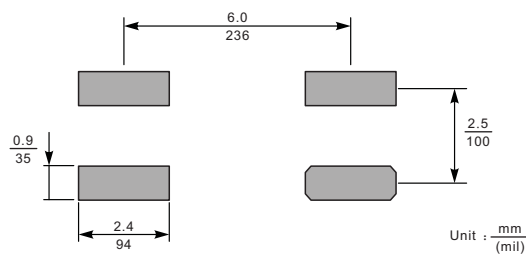
**MBS**

Plastic surface mounted package; 4 leads



UNIT		A	C	D	E	H <sub>E</sub>	d	e	L	L <sub>1</sub>	a	∠
mm	max	2.6	0.22	5.0	4.1	7.0	2.7	0.7	1.7	1.1	0.2	7°
	min	2.2	0.15	4.5	3.6	6.4	2.3	0.5	1.3	0.5	—	
mil	max	102	8.7	197	161	276	106	28	67	43	8	
	min	94	5.9	177	142	252	91	20	51	20	—	

**The recommended mounting pad size**



**Summary of Packing Options**

Package	Packing Description	Packing Quantity	Industry Standard
MBS	Tape/Reel, 13" reel	3000	EIA-481-1